

FORM PTO-1449  
(Modified)

APR 27 2001

U.S. Department of Commerce  
Patent and Trademark Office

Attorney Docket No.: SSI-00700

Serial No.: 09 704,641

INFORMATION DISCLOSURE STATEMENT BY APPLICANT  
(Use Several Sheets If Necessary)

(37 CFR § 1.98(b))

Applicant: Maximilian A. Biberger et al.

Filing Date: November 1, 2000

Group Art Unit:

## U.S. PATENT DOCUMENTS

Examiner Initials		Serial Patent Number	Issue Date	Applicant Patentee	Class	Subclass	Filing Date
12	AA	5,866,005	02/02/99	DeSimone et al.	210	634	11/1/96
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						
	AO						
	AP						

## FOREIGN PATENTS OR PUBLISHED FOREIGN PATENT APPLICATIONS

		Document Number	Publication Date	Country Patent Office	Class	Subclass	Translation	
							Yes	No
	AQ	EP 0 836 895 A2	04/22/98	EP	B08B	7/00	X	
	AR	WO 99/49998	10/07/99	WO	B08B	5/00	X	
	AS							

## OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

	AT	"A Comparison of Chilled DI Water, Ozone and CO <sub>2</sub> -Based Supercritical Fluids as Replacements for Photoresist-Stripping Solvents" by J.B. Rubin et al., Physical Organic Chemistry Group (CST-12) Chemical Science & Technology Division Los Alamos National Laboratory, Los Alamos, New Mexico.					
	AU						
	AV						
	AW						
	AX						
	AY						
	AZ						

Examiner:

R. N. V.

Date Considered:

3-28-2002

EXAMINER:

Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

FORM PTO-1449  
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APR 18 2001

U.S. Department of Commerce  
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Attorney Docket No.: SSI-00700

Serial No.: 09 704,641

## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use Several Sheets If Necessary)

(37 CFR § 1.98(b))

Applicant: Biberger et al.

Filing Date: 11-01-00

Group Art Unit:

## U.S. PATENT DOCUMENTS

Examiner Initials		Serial / Patent Number	Issue Date	Applicant / Patentee	Class	Subclass	Filing Date
✓	AA	5,965,025	10-12-99	Wai et al.	210	634	1-21-98
✓	AB	5,888,050	3-30-99	Fitzgerald et al.	417	46	8-25-98
✓	AC	5,797,719	8-25-98	James et al.	417	46	10-30-96
✓	AD	5,730,874	3-24-98	Wai et al.	210	638	6-2-94
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						

## FOREIGN PATENTS OR PUBLISHED FOREIGN PATENT APPLICATIONS

		Document Number	Publication Date	Country / Patent Office	Class	Subclass	Translation	
							Yes	No
	AK							
	AL							
	AM							
	AN							
	AO							

## OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

	AP	
	AQ	
	AR	
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	AT	
	AU	
	AV	
	AW	
	AX	
	AY	
	AZ	

Examiner:

*Ramirez*

Date Considered: 3-28-2002

EXAMINER:

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FORM PTO-1419  
(Modified)U.S. Department of Commerce  
Patent and Trademark Office

Attorney Docket No.: SSI-00700

Serial No.: 09 704,641

**INFORMATION DISCLOSURE STATEMENT BY APPLICANT**  
(Use Several Sheets If Necessary)

(37 CFR § 1.98(b))

Applicant: Maximilian A. Biberger *et al.*

Filing Date: November 1, 2000

Group Art Unit: 2812

## U.S. PATENT DOCUMENTS

Examiner Initials		Serial - Patent Number	Issue Date	Applicant - Patentee	Class	Subclass	Filing Date
	AA	4,592,306	06/03/86	Gallego	118	719	11/30/84
	AB	4,670,126	06/02/87	Messer <i>et al.</i>	204	298	04/28/86
	AC	4,825,808	05/02/89	Takahashi <i>et al.</i>	118	719	07/08/87
	AD	4,951,601	08/28/90	Maydan <i>et al.</i>	118	719	06/23/89
	AE	5,934,856	08/10/99	Asakawa <i>et al.</i>	414	217	04/28/97
	AF	6,077,321	06/30/00	Adachi <i>et al.</i>	29	25.01	11/07/97

## FOREIGN PATENTS OR PUBLISHED FOREIGN PATENT APPLICATIONS

		Document Number	Publication Date	Country - Patent Office	Class	Subclass	Translation	
							Yes	No
	AG	EP 0 244 951 A2	11/11/87	EP	H 01 L	21.00		x
	AH	EP 0 272 141 A2	06/22/88	EP	H 01 L	21.00		x
	AI	GB 2 193 482 A	02/10/88	GB	B 25 J	18.02		x
	AJ	JP 10-144757	05/29/98	JP	H 01 L	21.68		x
	AK	JP 56-142629	11/07/81	JP	H 01 L	21.205		x
	AL	JP 60-238479	11/27/85	JP	C 23 C	14/56	x	
	AM	JP 60-246635	12/06/85	JP	H 01 L	21.302		x
	AN	JP 61-231166	10/15/86	JP	C 23 C	14.24		x
	AO	JP 63-303059	12/09/88	JP	C 23 C	14.22		x
	AP	WO 87/07309	12/03/87	WO	C 23 C	16.00		x
	AQ	WO 91/12629	08/22/91	WO	H 01 L	21.00		x
	AR	WO 99/186603	04/15/99	WO	H 01 L	21.00		x

## OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

AS	Hideaki Itakura <i>et al.</i> , "Multi-Chamber Dry Etching System", Solid State Technology, April 1982, pp. 209-214.
AT	
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Examiner

K. N. N.

Date Considered

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